

Single N-channel MOSFET with schottky diode

ELM16702EA-S

■ General description

ELM16702EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■ Features

- $V_{ds}=20V$
- $I_d=3.8A$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 65m\Omega$ ($V_{gs}=2.5V$)
- $R_{ds(on)} < 95m\Omega$ ($V_{gs}=1.8V$)
- Schottky diode
- $V_{ds(V)}=20V$
- $I_f=1A$
- $V_f < 0.5V@0.5A$

■ Maximum absolute ratings

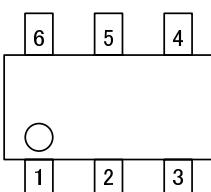
Parameter	Symbol	MOSFET	Schottky	Unit	Note
Drain-source voltage	V_{ds}	20		V	
Gate-source voltage	V_{gs}	± 8		V	
Continuous drain current	I_d	3.8		A	1
		3.0			
Pulsed drain current	I_{dm}	10		A	2
Schottky reverse voltage	V_{ka}		20	V	
Continuous forward current	I_f		2	A	1
			1		
Pulsed forward current	I_{fm}		10	A	2
Power dissipation	P_d	1.15	0.92	W	
		0.70	0.59		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	-55 to 150	°C	

■ Thermal characteristics

Parameter (MOSFET)		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	80.3	110.0	°C/W	1
Maximum junction-to-ambient	Steady-state		117.0	150.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	43.0	80.0	°C/W	3
Parameter (Schottky)			Symbol	Typ.	Max.	Unit
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	109.4	135.0	°C/W	1
Maximum junction-to-ambient	Steady-state		136.5	175.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	58.5	80.0	°C/W	3

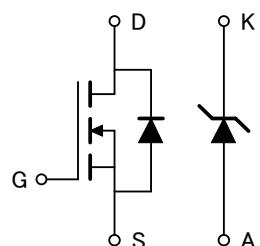
■ Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	ANODE
2	SOURCE
3	GATE
4	DRAIN
5	No connection
6	CATHODE

■ Circuit



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■ Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	20			V
Zero gate voltage drain current	Idss	Vds=16V Vgs=0V Tj=55°C			1 5	μA
Gate-body leakage current	Igss	Vds=0V, Vgs=±8V			100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA	0.4	0.6	1.0	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	10			A
Static drain-source on-resistance	Rds(on)	Vgs=4.5V Id=3.8A Tj=125°C		41.6 63.0	50.0 80.0	mΩ
		Vgs=2.5V, Id=3.3A		54.0	65.0	mΩ
		Vgs=1.8V, Id=2.8A		74.0	95.0	mΩ
Forward transconductance	Gfs	Vds=5V, Id=3.8A	10.5			S
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.8	1.0	V
Max. body-diode continuous current	Is				1.8	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		449.0		pF
Output capacitance	Coss			74.0		pF
Reverse transfer capacitance	Crss			51.6		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		4.9		Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	Vgs=4.5V, Vds=10V, Id=3.8A		5.90		nC
Gate-source charge	Qgs			0.36		nC
Gate-drain charge	Qgd			1.30		nC
Turn-on delay time	td(on)	Vgs=5V, Vds=10V RL=2.6 Ω, Rgen=0 Ω		4.5		ns
Turn-on rise time	tr			6.0		ns
Turn-off delay time	td(off)			32.7		ns
Turn-off fall time	tf			7.1		ns
Body diode reverse recovery time	trr	If=3.8A, dl/dt=100A/μs		13.0		ns
Body diode reverse recovery charge	Qrr	If=3.8A, dl/dt=100A/μs		3.3		nC
SCHOTTKY PARAMETERS						
Forward voltage drop	Vf	If=0.5A		0.39	0.50	V
Max. reverse leakage current	Irm	Vr=16V			0.02	
		Vr=16V, Tj=125°C			20.00	mA
Junction capacitance	Ct	Vr=10V		34		pF
Schottky reverse recovery time	trr	If=1A, dl/dt=100A/μs		5.2	10.0	ns
Schottky reverse recovery charge	Qrr	If=1A, dl/dt=100A/μs		0.8		nC

NOTE :

- The value of Rθja is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The Rθja is the sum of the thermal impedance from junction to lead Rθjl and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

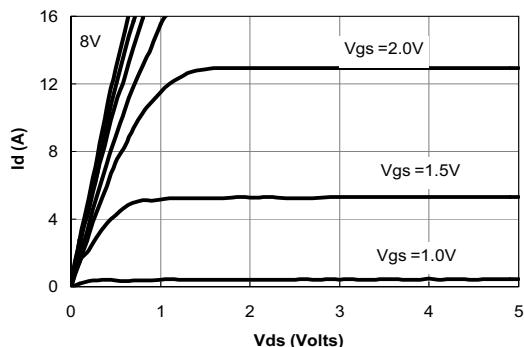


Figure 1: On-Regions Characteristics

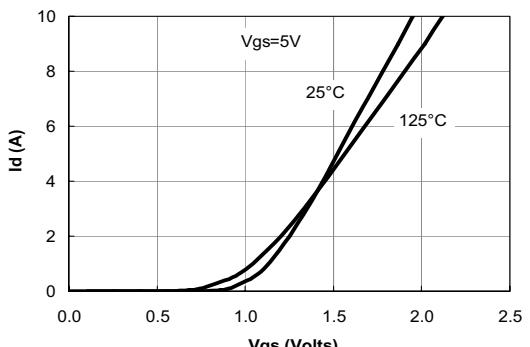


Figure 2: Transfer Characteristics

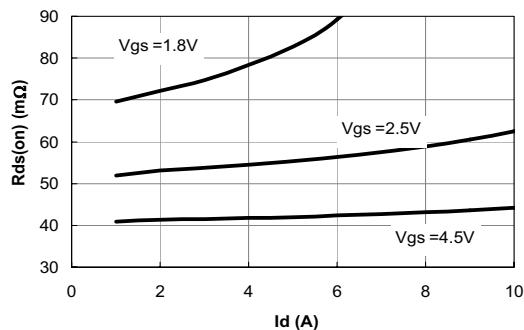


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

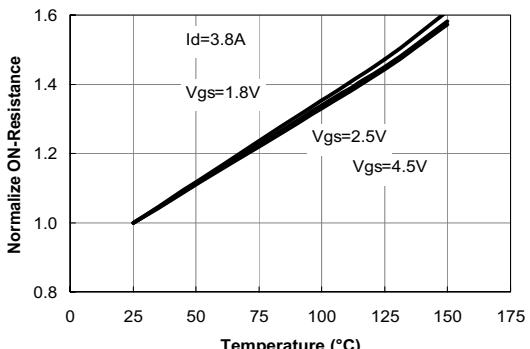


Figure 4: On-Resistance vs. Junction Temperature

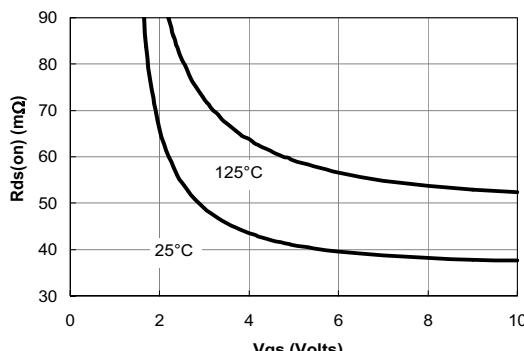


Figure 5: On-Resistance vs. Gate-Source Voltage

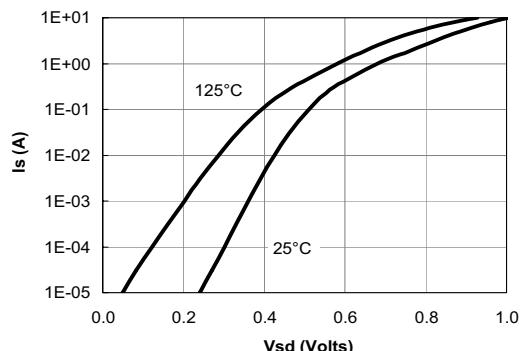
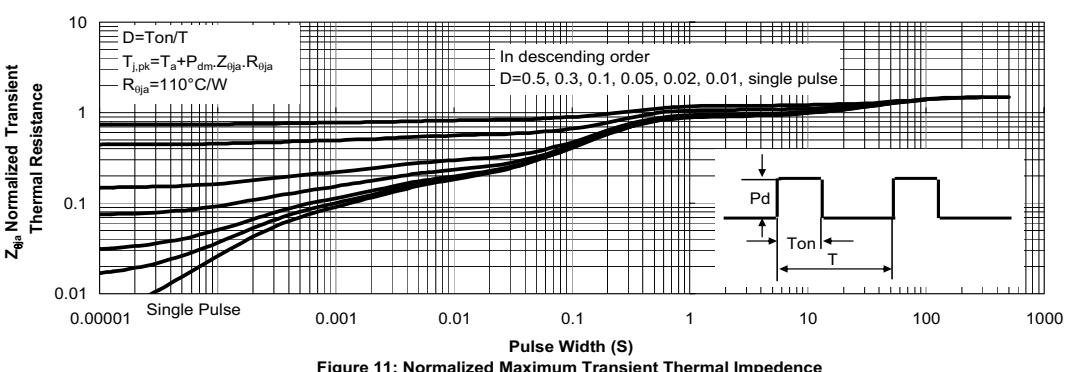
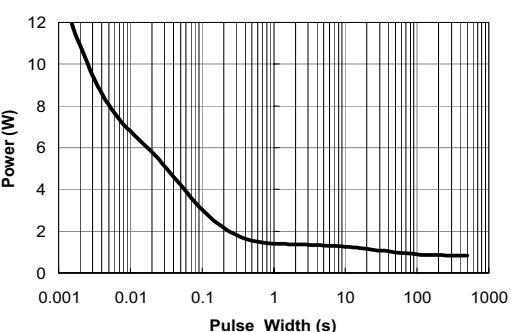
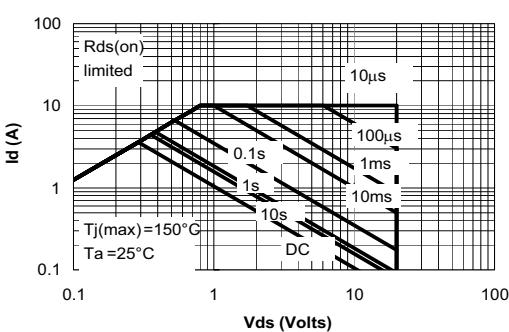
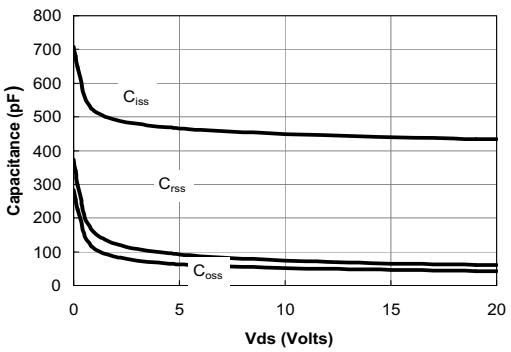
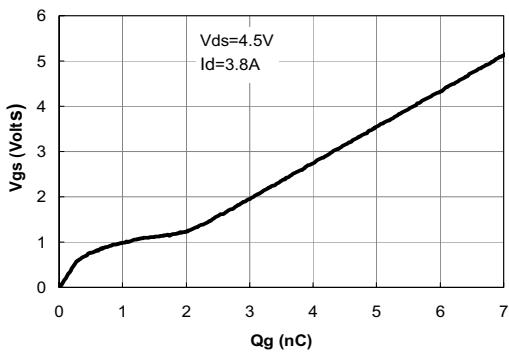


Figure 6: Body-Diode Characteristics

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■ Typical electrical and thermal characteristics (Schottky)

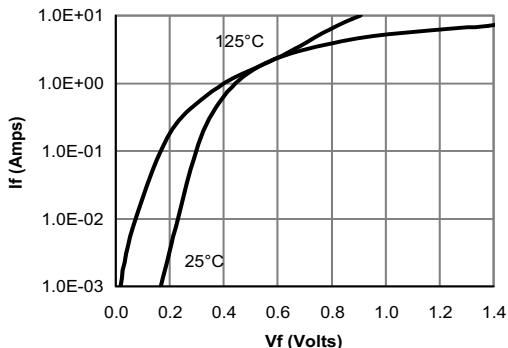


Figure 12: Schottky Forward Characteristics

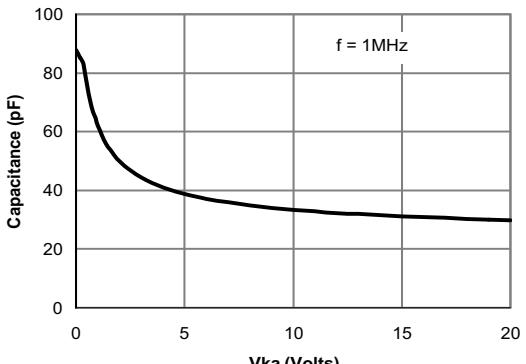


Figure 13: Schottky Capacitance Characteristics

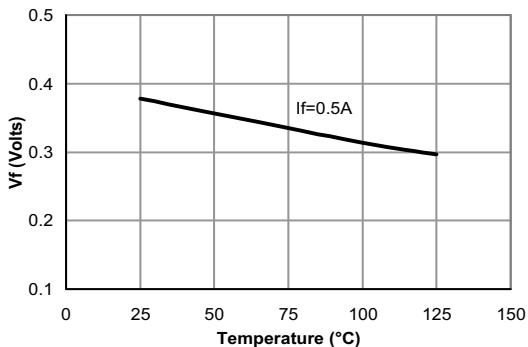


Figure 14: Schottky Forward Drop vs. Junction Temperature

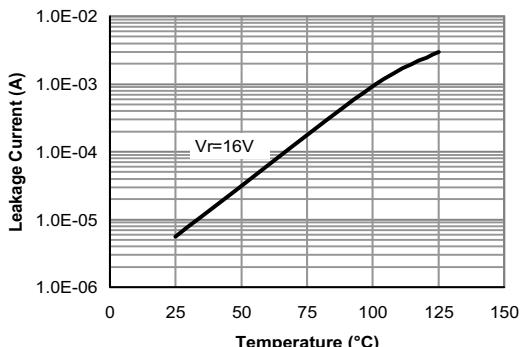


Figure 15: Schottky Leakage current vs. Junction Temperature

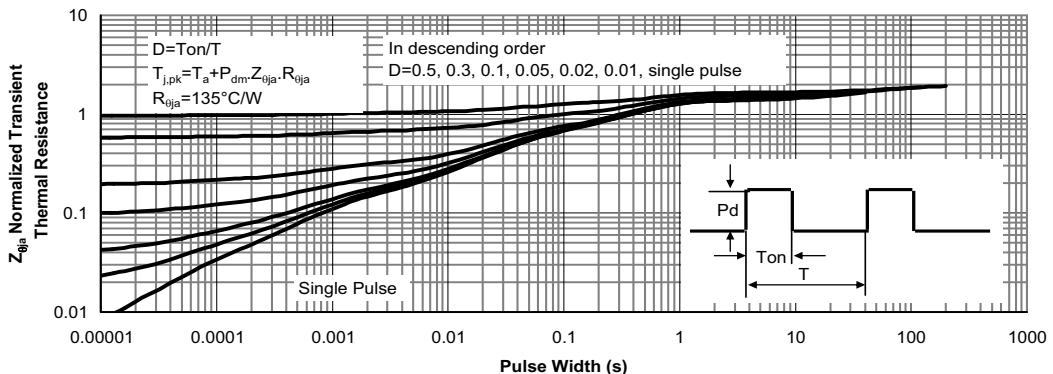


Figure 15: Schottky Normalized Maximum Transient Thermal Impedance